



Welcome to **E-XFL.COM** 

**Embedded - System On Chip (SoC):** The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are **Embedded - System On Chip (SoC)**?

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

Details	
Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	256KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	1.5GHz
Primary Attributes	FPGA - 220K Logic Elements
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FBGA, FC (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/10as022e3f27i2lg

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



# **Contents**

Inte	I <sup>®</sup> Arria <sup>®</sup> 10 Device Overview	3
	Key Advantages of Intel Arria 10 Devices	4
	Summary of Intel Arria 10 Features	
	Intel Arria 10 Device Variants and Packages	7
	Intel Arria 10 GX	7
	Intel Arria 10 GT	. 11
	Intel Arria 10 SX	. 14
	I/O Vertical Migration for Intel Arria 10 Devices	. 17
	Adaptive Logic Module	
	Variable-Precision DSP Block	. 18
	Embedded Memory Blocks	. 20
	Types of Embedded Memory	21
	Embedded Memory Capacity in Intel Arria 10 Devices	21
	Embedded Memory Configurations for Single-port Mode	
	Clock Networks and PLL Clock Sources	. 22
	Clock Networks	
	Fractional Synthesis and I/O PLLs	
	FPGA General Purpose I/O	
	External Memory Interface	
	Memory Standards Supported by Intel Arria 10 Devices	
	PCIe Gen1, Gen2, and Gen3 Hard IP	
	Enhanced PCS Hard IP for Interlaken and 10 Gbps Ethernet	
	Interlaken Support	
	10 Gbps Ethernet Support	
	Low Power Serial Transceivers	
	Transceiver Channels	
	PMA Features	
	PCS Features	
	SoC with Hard Processor System	
	Key Advantages of 20-nm HPS	
	Features of the HPS	
	FPGA Configuration and HPS Booting	37
	Hardware and Software Development	
	Dynamic and Partial Reconfiguration	
	Dynamic Reconfiguration	
	Partial Reconfiguration	
	Enhanced Configuration and Configuration via Protocol	
	SEU Error Detection and Correction	
	Power Management	
	Incremental Compilation	
	Document Revision History for Intel Arria 10 Device Overview	40



# Intel® Arria® 10 Device Overview

The Intel® Arria® 10 device family consists of high-performance and power-efficient 20 nm mid-range FPGAs and SoCs.

Intel Arria 10 device family delivers:

- Higher performance than the previous generation of mid-range and high-end FPGAs.
- Power efficiency attained through a comprehensive set of power-saving technologies.

The Intel Arria 10 devices are ideal for high performance, power-sensitive, midrange applications in diverse markets.

Table 1. Sample Markets and Ideal Applications for Intel Arria 10 Devices

Market	Applications
Wireless	Channel and switch cards in remote radio heads     Mobile backhaul
Wireline	<ul> <li>40G/100G muxponders and transponders</li> <li>100G line cards</li> <li>Bridging</li> <li>Aggregation</li> </ul>
Broadcast	<ul> <li>Studio switches</li> <li>Servers and transport</li> <li>Videoconferencing</li> <li>Professional audio and video</li> </ul>
Computing and Storage	Flash cache     Cloud computing servers     Server acceleration
Medical	Diagnostic scanners     Diagnostic imaging
Military	Missile guidance and control     Radar     Electronic warfare     Secure communications

#### **Related Information**

Intel Arria 10 Device Handbook: Known Issues

Lists the planned updates to the *Intel Arria 10 Device Handbook* chapters.

Intel Corporation. All rights reserved. Intel, the Intel logo, Altera, Arria, Cyclone, Enpirion, MAX, Nios, Quartus and Stratix words and logos are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. Intel warrants performance of its FPGA and semiconductor products to current specifications in accordance with Intel's standard warranty, but reserves the right to make changes to any products and services at any time without notice. Intel assumes no responsibility or liability arising out of the application or use of any information, product, or service described herein except as expressly agreed to in writing by Intel. Intel customers are advised to obtain the latest version of device specifications before relying on any published information and before placing orders for products or services.

ISO 9001:2008 Registered



# **Key Advantages of Intel Arria 10 Devices**

Table 2. Key Advantages of the Intel Arria 10 Device Family

Advantage	Supporting Feature
Enhanced core architecture	Built on TSMC's 20 nm process technology     60% higher performance than the previous generation of mid-range FPGAs     15% higher performance than the fastest previous-generation FPGA
High-bandwidth integrated transceivers	<ul> <li>Short-reach rates up to 25.8 Gigabits per second (Gbps)</li> <li>Backplane capability up to 12.5 Gbps</li> <li>Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC)</li> </ul>
Improved logic integration and hard IP blocks	8-input adaptive logic module (ALM)     Up to 65.6 megabits (Mb) of embedded memory     Variable-precision digital signal processing (DSP) blocks     Fractional synthesis phase-locked loops (PLLs)     Hard PCI Express Gen3 IP blocks     Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps)
Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor	Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC)  Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric
Advanced power savings	Comprehensive set of advanced power saving features Power-optimized MultiTrack routing and core architecture Up to 40% lower power compared to previous generation of mid-range FPGAs Up to 60% lower power compared to previous generation of high-end FPGAs

# **Summary of Intel Arria 10 Features**

**Table 3.** Summary of Features for Intel Arria 10 Devices

Feature	Description
Technology	TSMC's 20-nm SoC process technology Allows operation at a lower V <sub>CC</sub> level of 0.82 V instead of the 0.9 V standard V <sub>CC</sub> core voltage
Packaging	<ul> <li>1.0 mm ball-pitch Fineline BGA packaging</li> <li>0.8 mm ball-pitch Ultra Fineline BGA packaging</li> <li>Multiple devices with identical package footprints for seamless migration between different FPGA densities</li> <li>Devices with compatible package footprints allow migration to next generation high-end Stratix® 10 devices</li> <li>RoHS, leaded<sup>(1)</sup>, and lead-free (Pb-free) options</li> </ul>
High-performance FPGA fabric	<ul> <li>Enhanced 8-input ALM with four registers</li> <li>Improved multi-track routing architecture to reduce congestion and improve compilation time</li> <li>Hierarchical core clocking architecture</li> <li>Fine-grained partial reconfiguration</li> </ul>
Internal memory blocks	M20K—20-Kb memory blocks with hard error correction code (ECC)     Memory logic array block (MLAB)—640-bit memory
	continued

<sup>(1)</sup> Contact Intel for availability.

#### A10-OVERVIEW | 2018.04.09



Feature	Description					
Embedded Hard IP blocks	Variable-precision DSP	<ul> <li>Native support for signal processing precision levels from 18 x 19 to 54 x 54</li> <li>Native support for 27 x 27 multiplier mode</li> <li>64-bit accumulator and cascade for systolic finite impulse responses (FIRs)</li> <li>Internal coefficient memory banks</li> <li>Preadder/subtractor for improved efficiency</li> <li>Additional pipeline register to increase performance and reduce power</li> <li>Supports floating point arithmetic:         <ul> <li>Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication.</li> <li>Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability.</li> <li>Dynamic accumulator reset control.</li> <li>Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks.</li> </ul> </li> </ul>				
	Memory controller	DDR4, DDR3, and DDR3L				
	PCI Express*	PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port				
	Transceiver I/O	10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC)     PCS hard IPs that support:				
Core clock networks	<ul> <li>667 MHz externa</li> <li>800 MHz LVDS in</li> <li>Global, regional, and</li> </ul>	c clocking, depending on the application: I memory interface clocking with 2,400 Mbps DDR4 interface terface clocking with 1,600 Mbps LVDS interface I peripheral clock networks are not used can be gated to reduce dynamic power				
Phase-locked loops (PLLs)	<ul> <li>Support integer r</li> <li>Fractional mode s</li> <li>Integer PLLs:</li> <li>Adjacent to gene</li> </ul>	rnthesis, clock delay compensation, and zero delay buffering (ZDB) mode and fractional mode support with third-order delta-sigma modulation				
FPGA General-purpose I/Os (GPIOs)	On-chip termination	ry pair can be configured as receiver or transmitter (OCT) -ended LVTTL/LVCMOS interfacing				
External Memory Interface	Hard memory controller— DDR4, DDR3, and DDR3L support     DDR4—speeds up to 1,200 MHz/2,400 Mbps     DDR3—speeds up to 1,067 MHz/2,133 Mbps     Soft memory controller—provides support for RLDRAM 3 <sup>(2)</sup> , QDR IV <sup>(2)</sup> , and QDR II+      continued  continued					



Feature	Description					
Low-power serial transceivers	- Intel Arria 10 GT- Backplane support: - Intel Arria 10 GX- Intel Arria 10 GT- Extended range dow ATX transmit PLLs w Electronic Dispersion module Adaptive linear and of	rria 10 GX—1 Gbps to 17.4 Gbps rria 10 GT—1 Gbps to 25.8 Gbps				
HPS (Intel Arria 10 SX devices only)	Processor and system	Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability  256 KB on-chip RAM and 64 KB on-chip ROM  System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers  Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA)  ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage				
	External interfaces	Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller     Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-GO (OTG) controllers, I²C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os)				
	Interconnects to core	High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller				
Configuration	Enhanced 256-bit ad	comprehensive design protection to protect your valuable IP investments dvanced encryption standard (AES) design security with authentication obtocol (CvP) using PCIe Gen1, Gen2, or Gen3				
		continued				

 $<sup>^{(2)}</sup>$  Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



Feature	Description
	<ul> <li>Dynamic reconfiguration of the transceivers and PLLs</li> <li>Fine-grained partial reconfiguration of the core fabric</li> <li>Active Serial x4 Interface</li> </ul>
Power management	SmartVID     Low static power device options     Programmable Power Technology     Intel Quartus Prime integrated power analysis
Software and tools	<ul> <li>Intel Quartus Prime design suite</li> <li>Transceiver toolkit</li> <li>Platform Designer system integration tool</li> <li>DSP Builder for Intel FPGAs</li> <li>OpenCL™ support</li> <li>Intel SoC FPGA Embedded Design Suite (EDS)</li> </ul>

#### **Related Information**

Intel Arria 10 Transceiver PHY Overview

Provides details on Intel Arria 10 transceivers.

# **Intel Arria 10 Device Variants and Packages**

#### Table 4. **Device Variants for the Intel Arria 10 Device Family**

Variant	Description
Intel Arria 10 GX	FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.
Intel Arria 10 GT	<ul> <li>FPGA featuring:</li> <li>17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.</li> <li>25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules.</li> </ul>
Intel Arria 10 SX	SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.

### **Intel Arria 10 GX**

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

#### **Related Information**

Intel FPGA Product Selector

Provides the latest information on Intel products.



Table 6. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)

Re	source	Product Line					
		GX 570	GX 900	GX 1150			
Logic Elements	s (LE) (K)	570	660	900	1,150		
ALM		217,080	251,680	339,620	427,200		
Register		868,320	1,006,720	1,358,480	1,708,800		
Memory (Kb)	M20K	36,000	42,620	48,460	54,260		
	MLAB	5,096	5,788	9,386	12,984		
Variable-precision DSP Block		1,523	1,687	1,518	1,518		
18 x 19 Multip	lier	3,046	3,374	3,036	3,036		
PLL	Fractional Synthesis	16	16	32	32		
	I/O	16	16	16	16		
17.4 Gbps Trai	nsceiver	48	48	96	96		
GPIO (3)		696	696	768	768		
LVDS Pair (4)		324	324	384	384		
PCIe Hard IP Block		2	2	4	4		
Hard Memory Controller		16	16	16	16		

# **Package Plan**

# Table 7. Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)

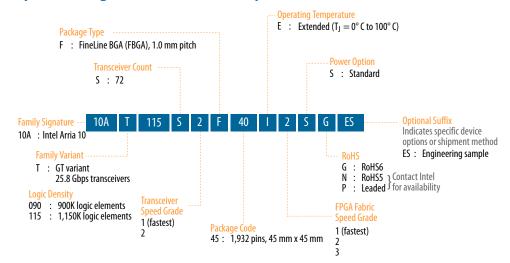
Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)		(19 mm × 19 mm, (27 mm × 27 mm,			F29 (29 mm × 29 mm, 780-pin FBGA)			
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
GX 160	48	192	6	48	192	12	48	240	12
GX 220	48	192	6	48	192	12	48	240	12
GX 270	_	_	_	48	192	12	48	312	12
GX 320	_	_	_	48	192	12	48	312	12
GX 480	_	_	_	_	_	_	48	312	12



### **Available Options**

Figure 2. Sample Ordering Code and Available Options for Intel Arria 10 GT Devices





#### **Maximum Resources**

Table 10. Maximum Resource Counts for Intel Arria 10 GT Devices

Reso	urce	Product Line		
		GT 900	GT 1150	
Logic Elements (LE) (K)		900	1,150	
ALM		339,620	427,200	
Register		1,358,480	1,708,800	
Memory (Kb)	M20K	48,460	54,260	
	MLAB	9,386	12,984	
Variable-precision DSP Block		1,518	1,518	
18 x 19 Multiplier		3,036	3,036	
PLL	Fractional Synthesis	32	32	
	I/O	16	16	
Transceiver	17.4 Gbps	72 <sup>(5)</sup>	72 <sup>(5)</sup>	
	25.8 Gbps	6	6	
GPIO <sup>(6)</sup>		624	624	
LVDS Pair <sup>(7)</sup>		312	312	
PCIe Hard IP Block		4	4	
Hard Memory Controller		16	16	

#### **Related Information**

Intel Arria 10 GT Channel Usage

Configuring GT/GX channels in Intel Arria 10 GT devices.

#### **Package Plan**

#### Table 11. Package Plan for Intel Arria 10 GT Devices

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	SF45 (45 mm × 45 mm, 1932-pin FBGA)			
	3 V I/O	LVDS I/O	XCVR	
GT 900	_	624	72	
GT 1150	_	624	72	

<sup>(5)</sup> If all 6 GT channels are in use, 12 of the GX channels are not usable.

<sup>(6)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(7)</sup> Each LVDS I/O pair can be used as differential input or output.



Variant	Product Line	Variable- precision DSP Block	Multiplications Operator		18 x 19 Multiplier Adder Sum	18 x 18 Multiplier Adder
		DSP BIOCK	18 x 19 Multiplier	27 x 27 Multiplier		Summed with 36 bit Input
	SX 320	984	1,968	984	984	984
	SX 480	1,368	2,736	1,368	1,368	1,368
	SX 570	1,523	3,046	1,523	1,523	1,523
	SX 660	1,687	3,374	1,687	1,687	1,687

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

Variant	Product Line	Variable- precision DSP Block	Single Precision Floating-Point Multiplication Mode	Single-Precision Floating-Point Adder Mode	Single- Precision Floating-Point Multiply Accumulate Mode	Peak Giga Floating- Point Operations per Second (GFLOPs)
Intel Arria 10	GX 160	156	156	156	156	140
GX	GX 220	192	192	192	192	173
	GX 270	830	830	830	830	747
	GX 320	984	984	984	984	886
	GX 480	1,369	1,368	1,368	1,368	1,231
	GX 570	1,523	1,523	1,523	1,523	1,371
	GX 660	1,687	1,687	1,687	1,687	1,518
	GX 900	1,518	1,518	1,518	1,518	1,366
	GX 1150	1,518	1,518	1,518	1,518	1,366
Intel Arria 10	GT 900	1,518	1,518	1,518	1,518	1,366
GT	GT 1150	1,518	1,518	1,518	1,518	1,366
Intel Arria 10	SX 160	156	156	156	156	140
SX	SX 220	192	192	192	192	173
	SX 270	830	830	830	830	747
	SX 320	984	984	984	984	886
	SX 480	1,369	1,368	1,368	1,368	1,231
	SX 570	1,523	1,523	1,523	1,523	1,371
	SX 660	1,687	1,687	1,687	1,687	1,518

# **Embedded Memory Blocks**

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices

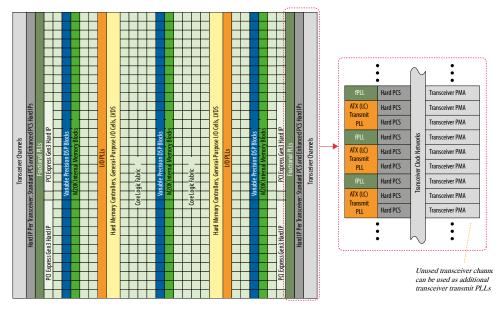
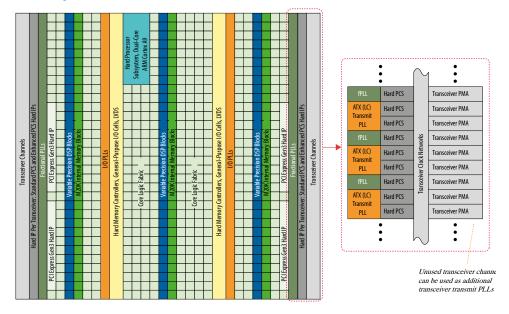


Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



#### **PMA Features**

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



Each transceiver channel contains a channel PLL that can be used as the CMU PLL or clock data recovery (CDR) PLL. In CDR mode, the channel PLL recovers the receiver clock and data in the transceiver channel. Up to 80 independent data rates can be configured on a single Intel Arria 10 device.

Table 23. PMA Features of the Transceivers in Intel Arria 10 Devices

Feature	Capability
Chip-to-Chip Data Rates	1 Gbps to 17.4 Gbps (Intel Arria 10 GX devices) 1 Gbps to 25.8 Gbps (Intel Arria 10 GT devices)
Backplane Support	Drive backplanes at data rates up to 12.5 Gbps
Optical Module Support	SFP+/SFP, XFP, CXP, QSFP/QSFP28, CFP/CFP2/CFP4
Cable Driving Support	SFP+ Direct Attach, PCI Express over cable, eSATA
Transmit Pre-Emphasis	4-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss
Continuous Time Linear Equalizer (CTLE)	Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss
Decision Feedback Equalizer (DFE)	7-fixed and 4-floating tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments
Variable Gain Amplifier	Optimizes the signal amplitude prior to the CDR sampling and operates in fixed and adaptive modes
Altera Digital Adaptive Parametric Tuning (ADAPT)	Fully digital adaptation engine to automatically adjust all link equalization parameters—including CTLE, DFE, and variable gain amplifier blocks—that provide optimal link margin without intervention from user logic
Precision Signal Integrity Calibration Engine (PreSICE)	Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance
Advanced Transmit (ATX) PLL	Low jitter ATX (LC tank based) PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols
Fractional PLLs	On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost
Digitally Assisted Analog CDR	Superior jitter tolerance with fast lock time
Dynamic Partial Reconfiguration	Allows independent control of the Avalon memory-mapped interface of each transceiver channel for the highest transceiver flexibility
Multiple PCS-PMA and PCS- PLD interface widths	8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency

### **PCS Features**

This table summarizes the Intel Arria 10 transceiver PCS features. You can use the transceiver PCS to support a wide range of protocols ranging from 1 Gbps to 25.8 Gbps.





PCS	Description
Standard PCS	<ul> <li>Operates at a data rate up to 12 Gbps</li> <li>Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS</li> <li>Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules.</li> </ul>
Enhanced PCS	<ul> <li>Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA</li> <li>Handles data transfer to and from the FPGA fabric</li> <li>Handles data transfer internally to and from the PMA</li> <li>Provides frequency compensation</li> <li>Performs channel bonding for multi-channel low skew applications</li> </ul>
PCIe Gen3 PCS	<ul> <li>Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates</li> <li>Provides support for PIPE 3.0 features</li> <li>Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed</li> </ul>

#### **Related Information**

- PCIe Gen1, Gen2, and Gen3 Hard IP on page 26
- Interlaken Support on page 26
- 10 Gbps Ethernet Support on page 26

### **PCS Protocol Support**

This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

Protocol	Data Rate (Gbps)	Transceiver IP	PCS Support
PCIe Gen3 x1, x2, x4, x8	8.0	Native PHY (PIPE)	Standard PCS and PCIe Gen3 PCS
PCIe Gen2 x1, x2, x4, x8	5.0	Native PHY (PIPE)	Standard PCS
PCIe Gen1 x1, x2, x4, x8	2.5	Native PHY (PIPE)	Standard PCS
1000BASE-X Gigabit Ethernet	1.25	Native PHY	Standard PCS
1000BASE-X Gigabit Ethernet with IEEE 1588v2	1.25	Native PHY	Standard PCS
10GBASE-R	10.3125	Native PHY	Enhanced PCS
10GBASE-R with IEEE 1588v2	10.3125	Native PHY	Enhanced PCS
10GBASE-R with KR FEC	10.3125	Native PHY	Enhanced PCS
10GBASE-KR and 1000BASE-X	10.3125	1G/10GbE and 10GBASE-KR PHY	Standard PCS and Enhanced PCS
Interlaken (CEI-6G/11G)	3.125 to 17.4	Native PHY	Enhanced PCS
SFI-S/SFI-5.2	11.2	Native PHY	Enhanced PCS
10G SDI	10.692	Native PHY	Enhanced PCS
	•		continued



Protocol	Data Rate (Gbps)	Transceiver IP	PCS Support
CPRI 6.0 (64B/66B)	0.6144 to 10.1376	Native PHY	Enhanced PCS
CPRI 4.2 (8B/10B)	0.6144 to 9.8304	Native PHY	Standard PCS
OBSAI RP3 v4.2	0.6144 to 6.144	Native PHY	Standard PCS
SD-SDI/HD-SDI/3G-SDI	0.143 <sup>(12)</sup> to 2.97	Native PHY	Standard PCS

#### **Related Information**

#### Intel Arria 10 Transceiver PHY User Guide

Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

### **SoC with Hard Processor System**

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

<sup>(12)</sup> The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.



#### Table 24. **Improvements in 20 nm HPS**

This table lists the key improvements of the 20 nm HPS compared to the 28 nm HPS.

Advantages/ Improvements	Description
Increased performance and overdrive capability	While the nominal processor frequency is 1.2 GHz, the 20 nm HPS offers an "overdrive" feature which enables a higher processor operating frequency. This requires a higher supply voltage value that is unique to the HPS and may require a separate regulator.
Increased processor memory bandwidth and DDR4 support	Up to 64-bit DDR4 memory at 2,400 Mbps support is available for the processor. The hard memory controller for the HPS comprises a multi-port front end that manages connections to a single port memory controller. The multi-port front end allows logic core and the HPS to share ports and thereby the available bandwidth of the memory controller.
Flexible I/O sharing	<ul> <li>An advanced I/O pin muxing scheme allows improved sharing of I/O between the HPS and the core logic. The following types of I/O are available for SoC:</li> <li>17 dedicated I/Os—physically located inside the HPS block and are not accessible to logic within the core. The 17 dedicated I/Os are used for HPS clock, resets, and interfacing with boot devices, QSPI, and SD/MMC.</li> <li>48 direct shared I/O—located closest to the HPS block and are ideal for high speed HPS peripherals such as EMAC, USB, and others. There is one bank of 48 I/Os that supports direct sharing where the 48 I/Os can be shared 12 I/Os at a time.</li> <li>Standard (shared) I/O—all standard I/Os can be shared by the PPS peripherals and any logic within the core. For designs where more than 48 I/Os are required to fully use all the peripherals in the HPS, these I/Os can be connected through the core logic.</li> </ul>
EMAC core	Three EMAC cores are available in the HPS. The EMAC cores enable an application to support two redundant Ethernet connections; for example, backplane, or two EMAC cores for managing IEEE 1588 time stamp information while allowing a third EMAC core for debug and configuration. All three EMACs can potentially share the same time stamps, simplifying the 1588 time stamping implementation. A new serial time stamp interface allows core logic to access and read the time stamp values. The integrated EMAC controllers can be connected to external Ethernet PHY through the provided MDIO or I <sup>2</sup> C interface.
On-chip memory	The on-chip memory is updated to 256 KB support and can support larger data sets and real time algorithms.
ECC enhancements	Improvements in L2 Cache ECC management allow identification of errors down to the address level. ECC enhancements also enable improved error injection and status reporting via the introduction of new memory mapped access to syndrome and data signals.
HPS to FPGA Interconnect Backbone	Although the HPS and the Logic Core can operate independently, they are tightly coupled via a high-bandwidth system interconnect built from high-performance ARM AMBA AXI bus bridges. IP bus masters in the FPGA fabric have access to HPS bus slaves via the FPGA-to-HPS interconnect. Similarly, HPS bus masters have access to bus slaves in the core fabric via the HPS-to-FPGA bridge. Both bridges are AMBA AXI-3 compliant and support simultaneous read and write transactions. Up to three masters within the core fabric can share the HPS SDRAM controller with the processor. Additionally, the processor can be used to configure the core fabric under program control via a dedicated 32-bit configuration port.
FPGA configuration and HPS booting	The FPGA fabric and HPS in the SoCs are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.  You can configure the FPGA fabric and boot the HPS independently, in any order, providing you with more design flexibility.
Security	New security features have been introduced for anti-tamper management, secure boot, encryption (AES), and authentication (SHA).



#### Features of the HPS

The HPS has the following features:

- 1.2-GHz, dual-core ARM Cortex-A9 MPCore processor with up to 1.5-GHz via overdrive
  - ARMv7-A architecture that runs 32-bit ARM instructions, 16-bit and 32-bit
     Thumb instructions, and 8-bit Java byte codes in Jazelle style
  - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction
  - Instruction Efficiency 2.5 MIPS/MHz, which provides total performance of 7500 MIPS at 1.5 GHz
- Each processor core includes:
  - 32 KB of L1 instruction cache, 32 KB of L1 data cache
  - Single- and double-precision floating-point unit and NEON media engine
  - CoreSight debug and trace technology
  - Snoop Control Unit (SCU) and Acceleration Coherency Port (ACP)
- 512 KB of shared L2 cache
- 256 KB of scratch RAM
- Hard memory controller with support for DDR3, DDR4 and optional error correction code (ECC) support
- Multiport Front End (MPFE) Scheduler interface to the hard memory controller
- 8-channel direct memory access (DMA) controller
- QSPI flash controller with SIO, DIO, QIO SPI Flash support
- NAND flash controller (ONFI 1.0 or later) with DMA and ECC support, updated to support 8 and 16-bit Flash devices and new command DMA to offload CPU for fast power down recovery
- Updated SD/SDIO/MMC controller to eMMC 4.5 with DMA with CE-ATA digital command support
- 3 10/100/1000 Ethernet media access control (MAC) with DMA
- 2 USB On-the-Go (OTG) controllers with DMA
- 5 I<sup>2</sup>C controllers (3 can be used by EMAC for MIO to external PHY)
- 2 UART 16550 Compatible controllers
- 4 serial peripheral interfaces (SPI) (2 Master, 2 Slaves)
- 62 programmable general-purpose I/Os, which includes 48 direct share I/Os that allows the HPS peripherals to connect directly to the FPGA I/Os
- 7 general-purpose timers
- 4 watchdog timers
- Anti-tamper, Secure Boot, Encryption (AES) and Authentication (SHA)



#### **System Peripherals and Debug Access Port**

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

### **HPS-FPGA AXI Bridges**

The HPS-FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI $^{\text{\tiny M}}$ ) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows
  the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is
  primarily used for control and status register (CSR) accesses to peripherals in the
  FPGA fabric.

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS-FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

#### **HPS SDRAM Controller Subsystem**

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



Scheme	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompression	Design Security <sup>(1</sup> 4)	Partial Reconfiguration (15)	Remote System Update
Fast passive	8 bits	100	3200	Yes	Yes	Yes <sup>(17)</sup>	PFL IP
parallel (FPP) through CPLD or	16 bits			Yes	Yes		core
external microcontroller	32 bits			Yes	Yes		
Configuration via	16 bits	100	3200	Yes	Yes	Yes <sup>(17)</sup>	_
HPS	32 bits			Yes	Yes		
Configuration via Protocol [CvP (PCIe*)]	x1, x2, x4, x8 lanes	_	8000	Yes	Yes	Yes <sup>(16)</sup>	_

You can configure Intel Arria 10 devices through PCIe using Configuration via Protocol (CvP). The Intel Arria 10 CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

#### **SEU Error Detection and Correction**

Intel Arria 10 devices offer robust and easy-to-use single-event upset (SEU) error detection and correction circuitry.

The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running CRC error detection circuit with integrated ECC that automatically corrects one or two errors and detects higher order multi-bit errors. When more than two errors occur, correction is available through reloading of the core programming file, providing a complete design refresh while the FPGA continues to operate.

The physical layout of the Intel Arria 10 CRAM array is optimized to make the majority of multi-bit upsets appear as independent single-bit or double-bit errors which are automatically corrected by the integrated CRAM ECC circuitry. In addition to the CRAM protection, the M20K memory blocks also include integrated ECC circuitry and are layout-optimized for error detection and correction. The MLAB does not have ECC.

## **Power Management**

Intel Arria 10 devices leverage the advanced 20 nm process technology, a low 0.9 V core power supply, an enhanced core architecture, and several optional power reduction techniques to reduce total power consumption by as much as 40% compared to Arria V devices and as much as 60% compared to Stratix V devices.

<sup>(13)</sup> Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

<sup>(14)</sup> Encryption and compression cannot be used simultaneously.

<sup>(15)</sup> Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

<sup>(17)</sup> Supported at a maximum clock rate of 100 MHz.



The optional power reduction techniques in Intel Arria 10 devices include:

- SmartVID—a code is programmed into each device during manufacturing that allows a smart regulator to operate the device at lower core V<sub>CC</sub> while maintaining performance
- **Programmable Power Technology**—non-critical timing paths are identified by the Intel Quartus Prime software and the logic in these paths is biased for low power instead of high performance
- **Low Static Power Options**—devices are available with either standard static power or low static power while maintaining performance

Furthermore, Intel Arria 10 devices feature Intel's industry-leading low power transceivers and include a number of hard IP blocks that not only reduce logic resources but also deliver substantial power savings compared to soft implementations. In general, hard IP blocks consume up to 90% less power than the equivalent soft logic implementations.

### **Incremental Compilation**

The Intel Quartus Prime software incremental compilation feature reduces compilation time and helps preserve performance to ease timing closure. The incremental compilation feature enables the partial reconfiguration flow for Intel Arria 10 devices.

Incremental compilation supports top-down, bottom-up, and team-based design flows. This feature facilitates modular, hierarchical, and team-based design flows where different designers compile their respective design sections in parallel. Furthermore, different designers or IP providers can develop and optimize different blocks of the design independently. These blocks can then be imported into the top level project.

# **Document Revision History for Intel Arria 10 Device Overview**

Document Version	Changes
2018.04.09	Updated the lowest $V_{CC}$ from 0.83 V to 0.82 V in the topic listing a summary of the device features.

Date	Version	Changes
January 2018	2018.01.17	Updated the maximum data rate for HPS (Intel Arria 10 SX devices external memory interface DDR3 controller from 2,166 Mbps to 2,133 Mbps.
		Updated maximum frequency supported for half rate QDRII and QDRII     + SRAM to 633 MHz in Memory Standards Supported by the Soft     Memory Controller table.
		Updated transceiver backplane capability to 12.5 Gbps.
		Removed transceiver speed grade 5 in Sample Ordering Core and Available Options for Intel Arria 10 GX Devices figure.
	·	continued



Date	Version	Changes
December 2015	2015.12.14	Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb.
		Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources.
November 2015	2015.11.02	• Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660.
		Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in <b>Number of Multipliers in Intel Arria 10 Devices</b> table.
		<ul> <li>Updated the available options for Arria 10 GX, GT, and SX.</li> <li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li> </ul>
June 2015	2015.06.15	Corrected label for Intel Arria 10 GT product lines in the vertical migration figure.
May 2015	2015.05.15	Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller.
May 2015	2015.05.04	Added support for 13.5G JESD204b in the Summary of Features table.  Added support for 13.5G JESD204b in the Summary of Features table.
		Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic.
		Added a note to the table, Maximum Resource Counts for Arria 10 GT devices.
		Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic.
January 2015	2015.01.23	Added floating point arithmetic features in the Summary of Features table.
		Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb.
		Updated the table that lists the memory standards supported by Intel Arria 10 devices.
		<ul> <li>Removed support for DDR3U, LPDDR3 SDRAM, RLDRAM 2, and DDR2.</li> <li>Moved RLDRAM 3 support from hard memory controller to soft memory controller. RLDRAM 3 support uses hard PHY with soft memory controller.</li> </ul>
		Added soft memory controller support for QDR IV.
		Updated the maximum resource count table to include the number of hard memory controllers available in each device variant.
		Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps.
		Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz.
		Added a feature for fractional synthesis PLLs: PLL cascading.
		Updated the HPS programmable general-purpose I/Os from 54 to 62.
September 2014	2014.09.30	Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX.
		Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660.
		Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150.
		continued